## SQM40020EL

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RoHS

COMPLIANT HALOGEN

FREE

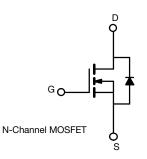
# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0022			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0027			
I <sub>D</sub> (A)	100			
Configuration	Single			
Package	TO-263			

### FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance
- 100 % R<sub>q</sub> and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	40	V
Gate-source voltage		V <sub>GS</sub>	± 20	v
Continuous drain current <sup>a</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub> -	100	
Continuous drain current ~	T <sub>C</sub> = 125 °C		100	
Continuous source current (diode conduction) a		I <sub>S</sub>	100	А
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	280	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	46	
Single pulse avalanche energy		E <sub>AS</sub>	105.8	mJ
Martin and a state to the b	T <sub>C</sub> = 25 °C	Р	150	W
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 125 °C	P <sub>D</sub>	50	vv
Operating junction and storage temperature	range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	1	0/10		

#### Notes

- a. Package limited
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)

MAX.

UNIT

MIN.

TYP.

**SQM40020EL** 

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SPECIFICA	TIONS ( $T_C = 25 \ ^\circ C$ , (	unless other	wise noted)
PARAMETER		SYMBOL	TEST CONDITIONS
Static			
Drain-source b	reakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \ \mu\text{A}$
Gate-source th	reshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$
0	-1		

Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		40	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		1.2	1.7	2.2	v	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50		
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	500	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	50	-	-	Α	
		$V_{GS} = 10 V$	I <sub>D</sub> = 20 A	-	0.00178	0.00220		
Drain courses on state resistance à	Р	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 15 A	-	0.00219	0.00270	0	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.00350	Ω	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.00420		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 20 A	-	115	-	S	
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	6445	8800	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	1931	2700		
Reverse transfer capacitance	C <sub>rss</sub>			-	179	250		
Total gate charge <sup>c</sup>	Qg		V <sub>DS</sub> = 20 V, I <sub>D</sub> = 50 A	-	108	165	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	23.3	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	20	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.9	1.83	2.8	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>				15	30		
Rise time <sup>c</sup>	tr	V <sub>DD</sub> =	= 20 V, $R_L$ = 0.4 $\Omega$	-	10	20		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 50$ Å,	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		50	100	- ns	
Fall time <sup>c</sup>	t <sub>f</sub>			-	20	40		
Source-Drain Diode Ratings and Chara	cteristics <sup>b</sup>	•						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	280	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 25 A, V <sub>GS</sub> = 0 V		-	0.8	1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 50 A, di/dt = 100 A/μs		-	43	90	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	31	65	nC	
Reverse recovery fall time	ta			-	13	-		
Reverse recovery rise time	t <sub>b</sub>			-	30	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.32	-	А	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

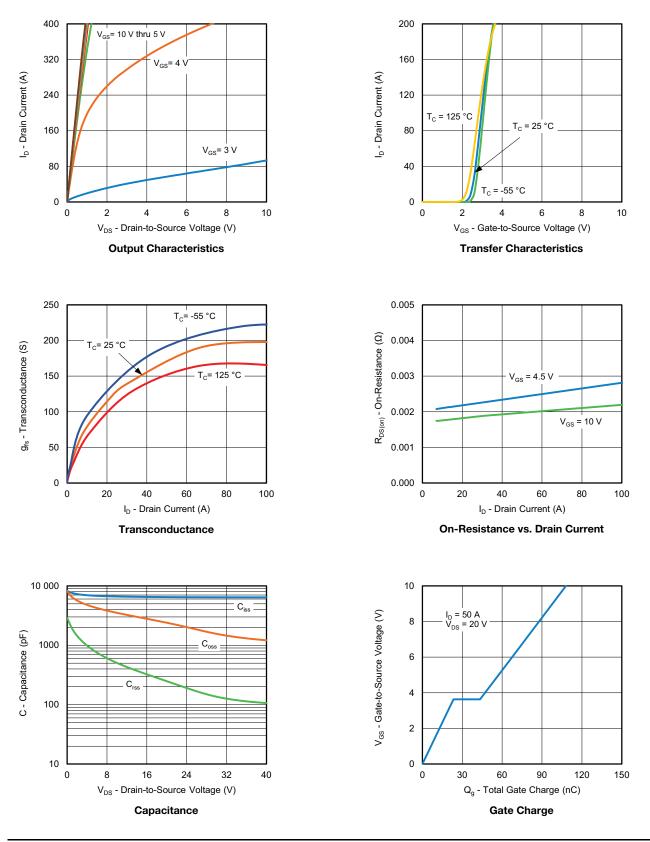
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



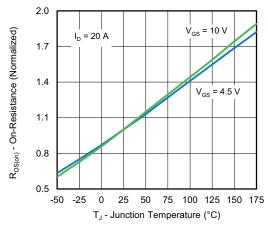
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3 stions contact: automostechsupp Document Number: 76899

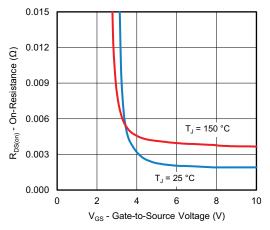
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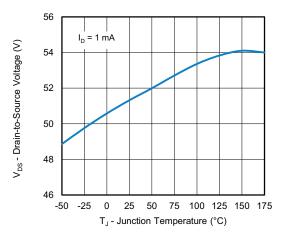
### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



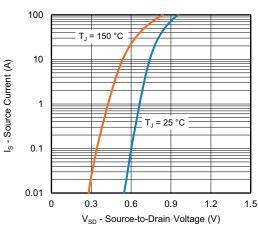
**On-Resistance vs. Junction Temperature** 



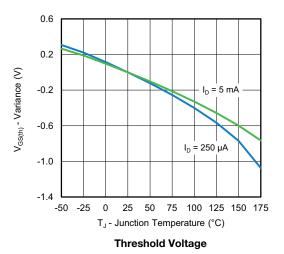
On-Resistance vs. Gate-to-Source Voltage

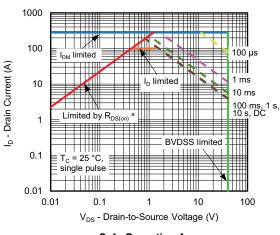


Drain Source Breakdown vs. Junction Temperature

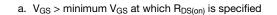


Source Drain Diode Forward Voltage





#### Safe Operating Area



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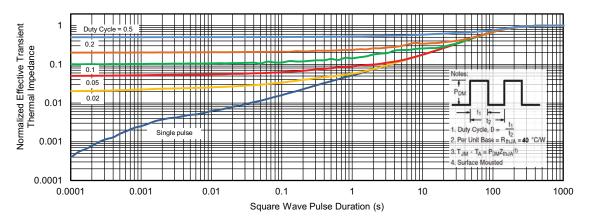
Note

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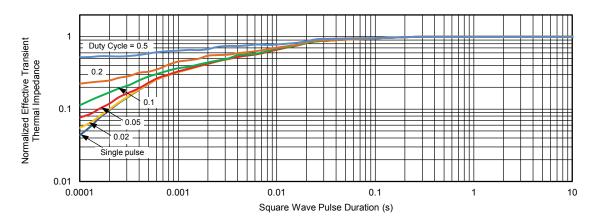
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### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

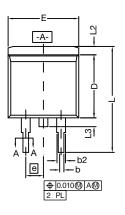
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

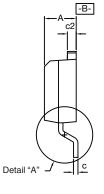
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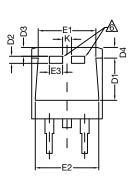
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TO-263 (D<sup>2</sup>PAK): 3-LEAD

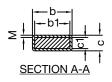








DETAIL A (ROTATED 90°)



		INCHES		MILLIN	IETERS	
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010 BSC		0.254 BSC		
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

#### Notes

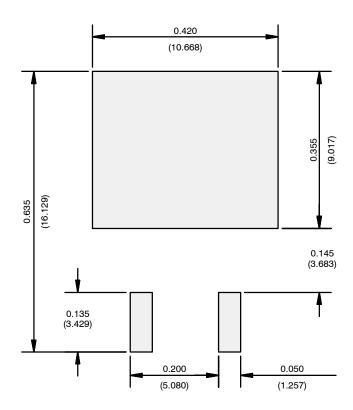
- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25  $\,\%\,$  of L1 can fall above seating plane by
- max. 8 mils. 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



## **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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